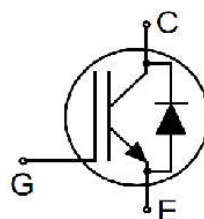




Features

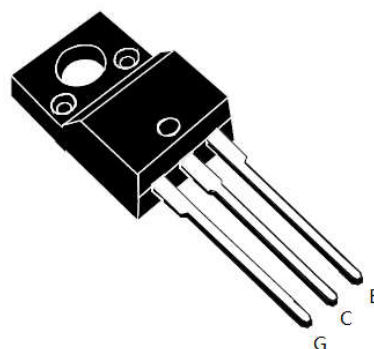
- Max Junction Temperature 150°C
- High breakdown voltage up to 650V for improved reliability
- Short Circuit Rated
- Very Low Saturation Voltage:
 $V_{CE(SAT)} = 1.65V$ (Typ.) @ $I_C = 15A$
- Soft current turn-off waveforms

V_{CE}	650	V
I_C	15	A
$V_{CE(SAT)} \quad I_C=15A$	1.65	V



Applications

- Soft switching applications
- Air conditioning
- Motor drive inverter



Product	Package	Packaging
IRGB4620D	TO-220MF	Tube



Maximum Ratings ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	650	V
DC collector current, limited by T_{jmax} $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_C	30 15	A
Diode Forward current, limited by T_{jmax} $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_F	30 15	A
Continuous Gate-emitter voltage	V_{GE}	± 20	V
Transient Gate-emitter voltage	V_{GE}	± 30	V
Turn off safe operating area $V_{CE} \leq 650\text{V}$, $T_j \leq 150^\circ\text{C}$	-	60	A
Pulsed collector current, $V_{GE}=15\text{V}$, t_p limited by T_{jmax}	I_{CM}	45	A
Short Circuit Withstand Time, $V_{GE}=15\text{V}$, $V_{CE} \leq 400\text{V}$	T_{sc}	5	μs
Power dissipation, $T_j=25^\circ\text{C}$	P_{tot}	27	W
Operating junction temperature	T_j	$-40 \dots +150$	$^\circ\text{C}$
Storage temperature	T_s	$-55 \dots +150$	$^\circ\text{C}$
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s	-	260	$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT thermal resistance, junction - case	$R_{\theta(j-c)}$	4.9	K/W
Diode thermal resistance, junction - case	$R_{\theta(j-c)}$	5.8	K/W
Thermal resistance, junction - ambient	$R_{\theta(j-a)}$	62.5	K/W



Electrical Characteristics of the IGBT ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Static Characteristics (Tested on wafers)						
BV_{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 1mA$	650	-	-	V
$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage	$I_C = 15A, V_{GE} = 15V$	-	1.65	1.95	V
$V_{GE(th)}$	G-E Threshold Voltage	$V_{GE} = V_{CE}, I_C = 250\mu A$	4.1	5.0	5.7	V
I_{CES}	Collector Cut-Off Current	$V_{CE} = 650V, V_{GE} = 0V$	-	-	10	μA
I_{GES}	G-E Leakage Current	$V_{GE} = \pm 20V, V_{CE} = 0V$	-	-	± 200	nA
g_{fs}	Transconductance	$V_{CE}=20V, I_C=15A$	-	10	-	S

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic						
Input capacitance	C_{ies}	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$	-	1910	-	pF
Output capacitance	C_{oes}		-	80	-	
Reverse transfer capacitance	C_{res}		-	46	-	
Gate charge	Q_G	$V_{CC} = 480V, I_C = 15A, V_{GE} = 15V$	-	92	-	nC
Short circuit collector current	$I_{C(SC)}$	$V_{GE}=15V, t_{SC} \leq 5us$ $V_{CC}=400V,$ $T_{j, start}=25^\circ C$	-	98	-	A



Switching Characteristic, Inductive Load ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Turn-on Delay Time	$t_{d(on)}$	$T_j = 25^\circ\text{C}$ $V_{CC} = 400\text{V}$, $I_C = 15\text{A}$, $V_{GE} = 0/15\text{V}$, $R_g = 12\Omega$	-	15	-	ns
Rise Time	t_r		-	25	-	ns
Turn-off Delay Time	$t_{d(off)}$		-	60	-	ns
Fall Time	t_f		-	46	-	ns
Turn-on Energy	E_{on}		-	0.75	-	mJ
Turn-off Energy	E_{off}		-	0.1	-	mJ

Electrical Characteristics of the DIODE ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic						
Diode Forward Voltage	V_{FM}	$I_F = 15\text{A}$	-	1.7	-	V
Reverse Recovery Time	T_{rr}	$I_F = 15\text{A}$ $V_R = 300\text{V}$, $di/dt = 200\text{A}/\mu\text{s}$	-	50	-	ns
Reverse Recovery Current	I_{rr}		-	4	-	A
Reverse Recovery Charge	Q_{rr}		-	83	-	nC



Fig. 1 FBSOA characteristics

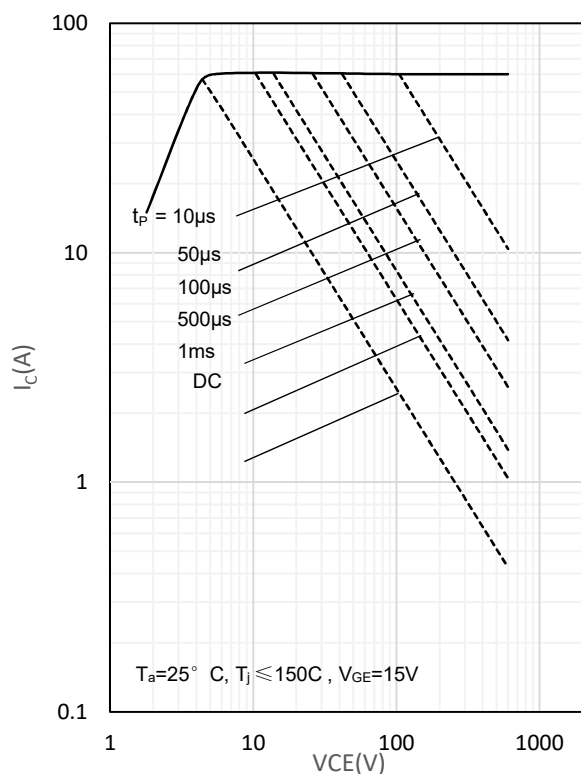


Fig. 2 Load Current vs. Frequency

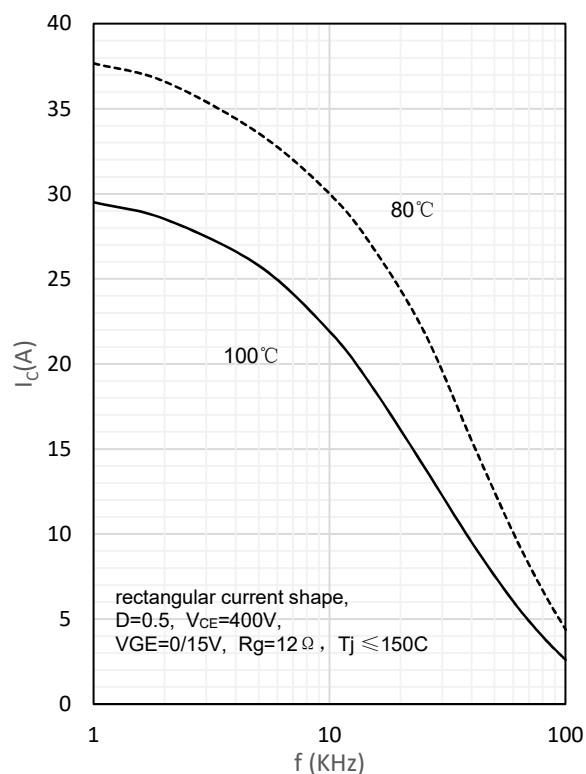


Fig. 3 Output characteristics

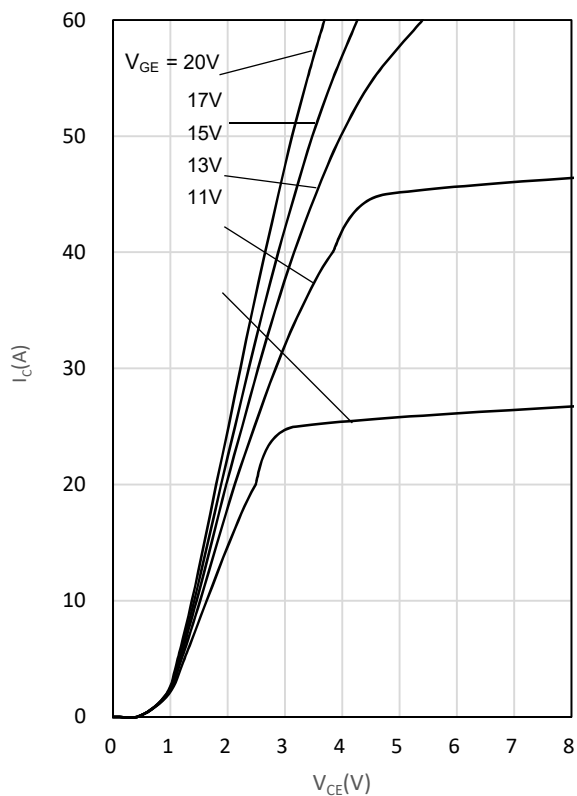


Fig. 4 Saturation voltage characteristics

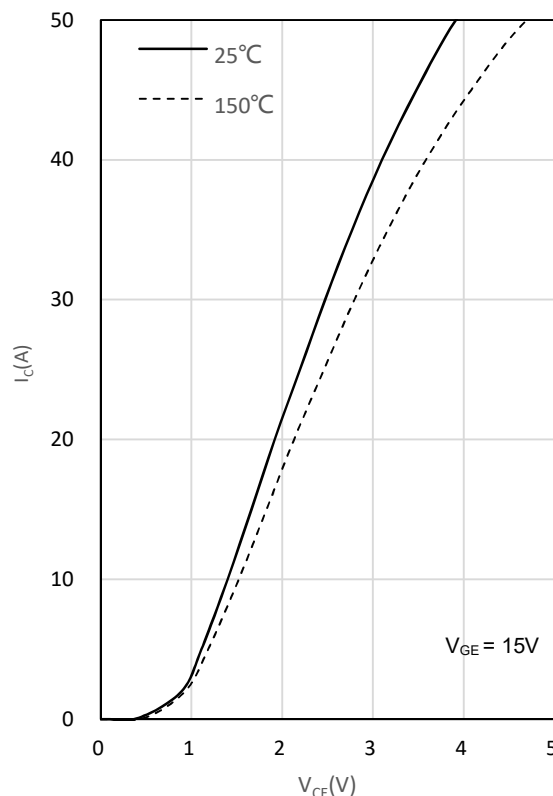




Fig. 5 Switching times vs. gate resistor

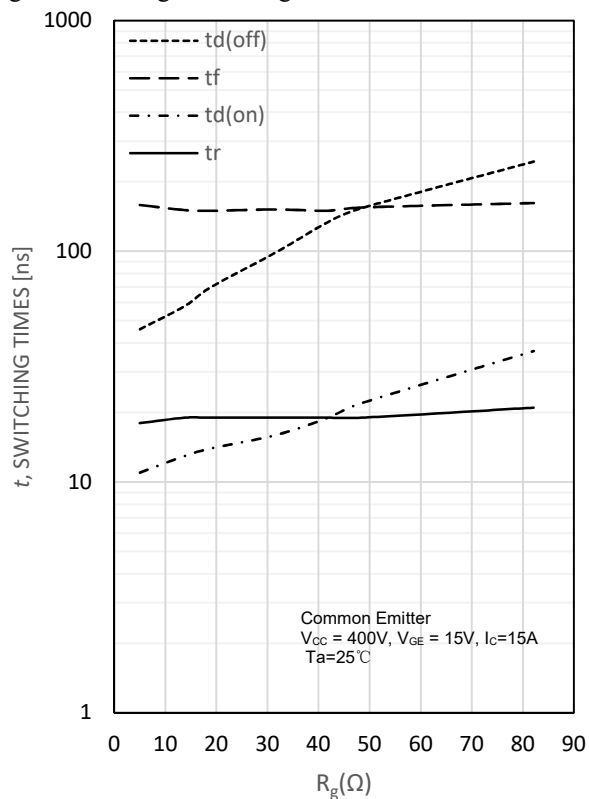


Fig. 6 Switching times vs. collector current

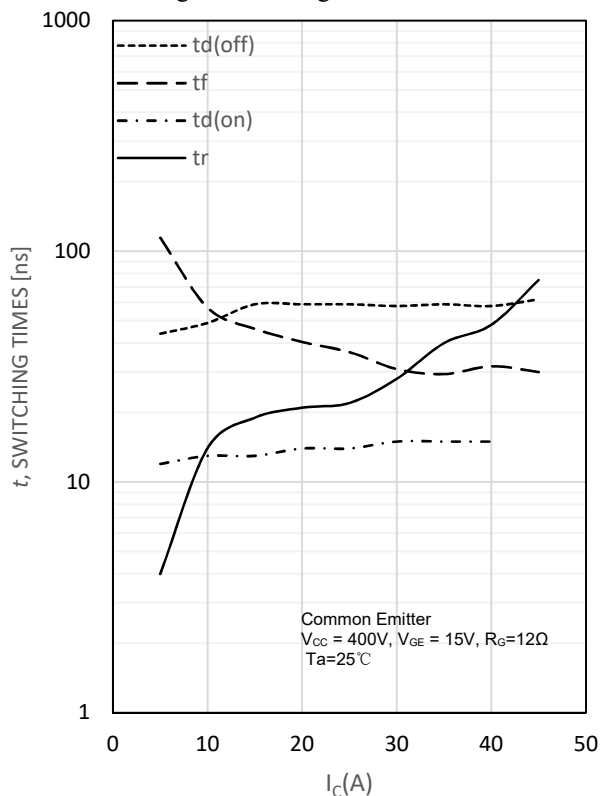


Fig. 7 Switching loss vs. gate resistor

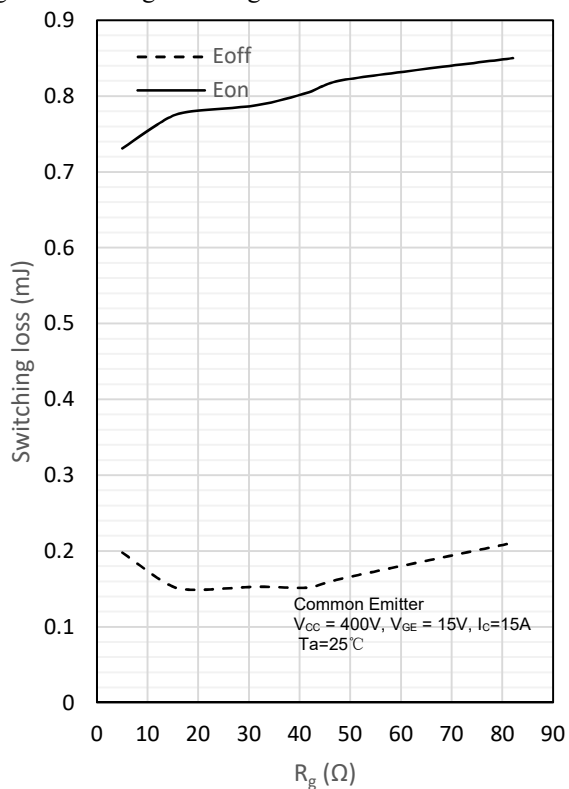


Fig. 8 Switching loss vs. collector current

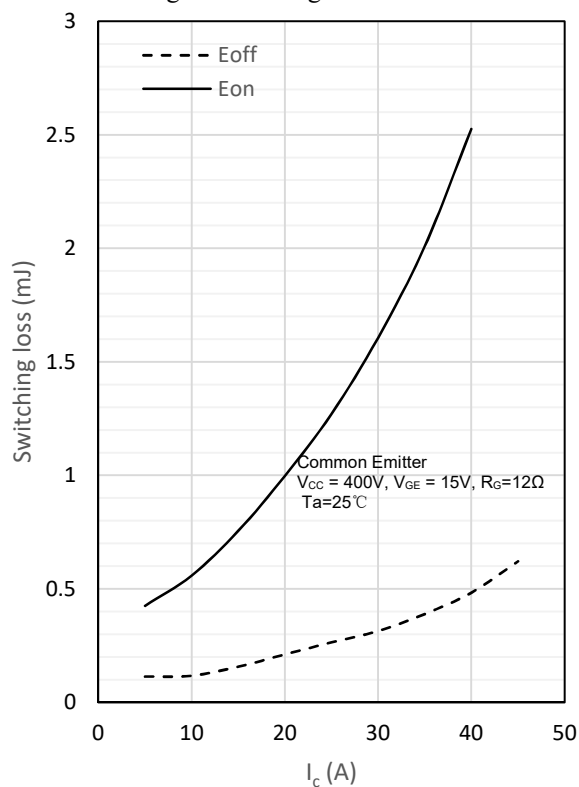




Fig. 9 Gate charge characteristics

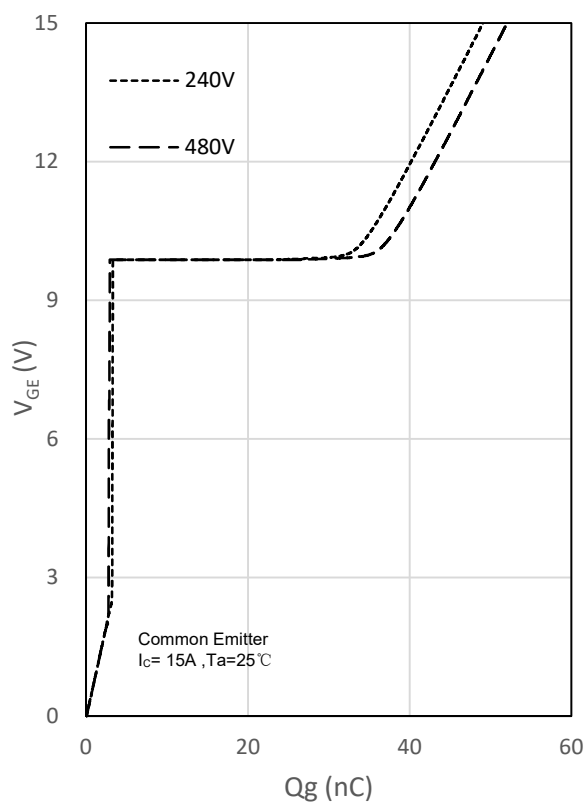
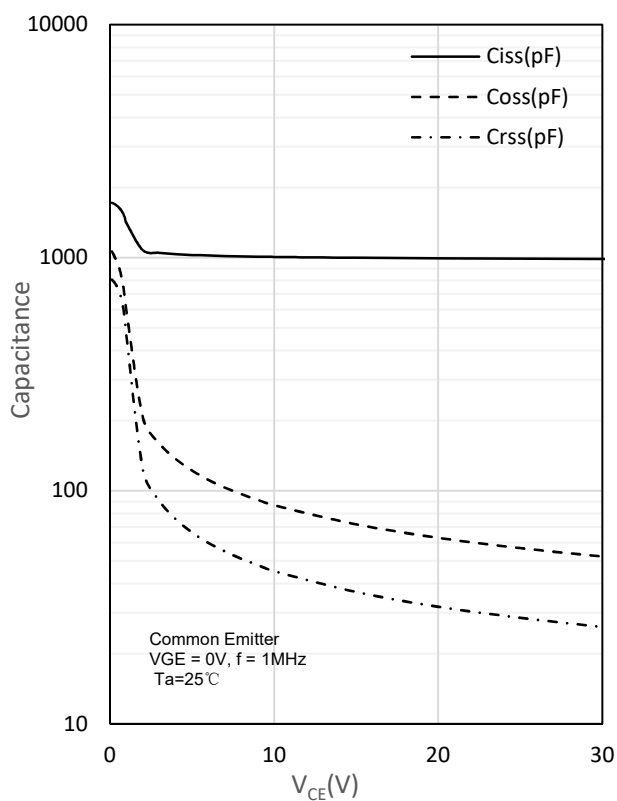
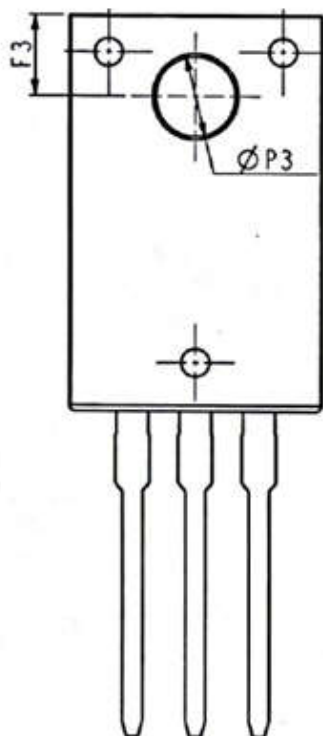
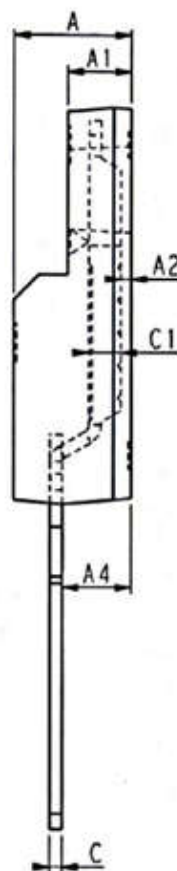
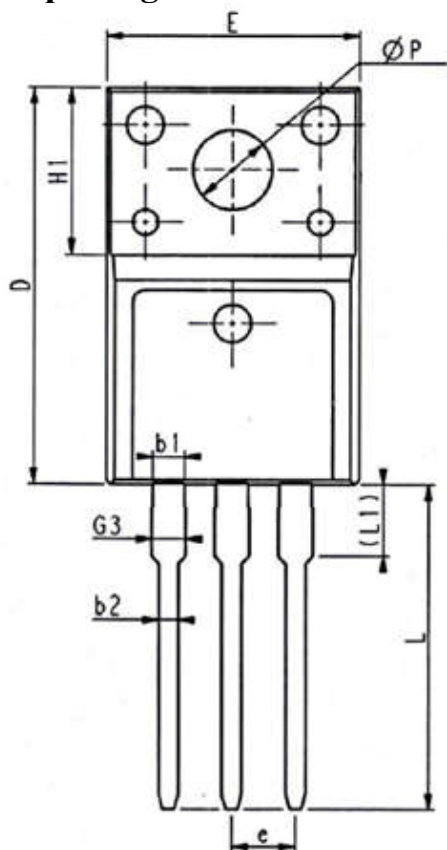


Fig. 10 Capacitance characteristics



**TO-220MF package information**

SYMBOL			
	MIN	NOM	MAX
E	9.96	10.16	10.36
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A2	0.30	0.45	0.60
A4	2.56	2.76	2.96
c	0.40	0.50	0.65
c1	1.20	1.30	1.35
D	15.57	15.87	16.17
H1	6.70REF		
e	2.54BSC		
L	12.68	12.98	13.28
L1	2.88	3.03	3.18
ΦP	3.03	3.18	3.38
ΦP3	3.15	3.45	3.65
F3	3.15	3.30	3.45
G3	1.25	1.35	1.55
b1	1.18	1.28	1.43
b2	0.70	0.80	0.95